/ Descriptions

VRW056 ṂṂ Ł SQS ÆṀ ч s ǁ ᒣ Silicon PNP transistor in a SOT-23 Plastic Package.

/ Features

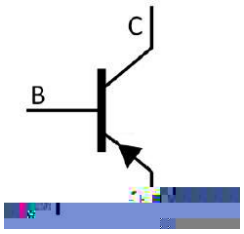
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Low saturation voltage, excellent h_{FE} linearity and high h_{FE}.

[redacted]

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Output stage of audio amplifier, voltage regulator, DC-DC converter and relay driver.





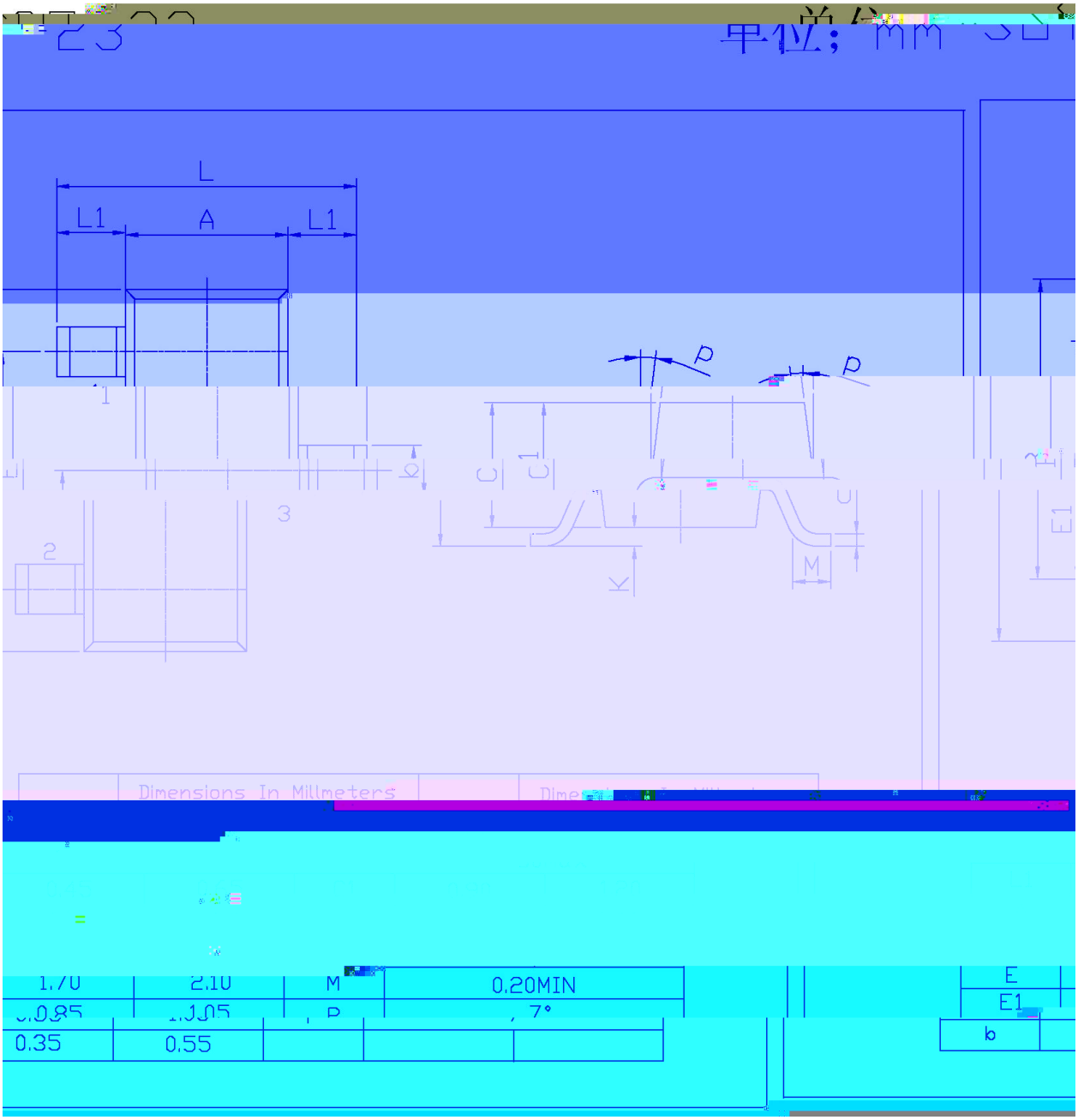
PIN1 χ Base PIN 2 χ Emitter PIN 3 χ Collector

/ h_{FE} Classifications & Marking

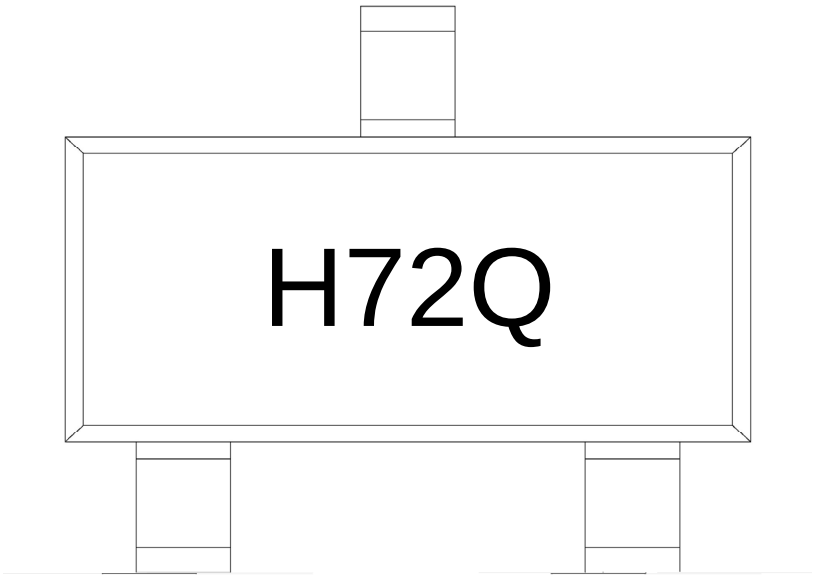
v ˝Ǫ Parameter	ϒ N Symbol	˝Ǫ Ö Rating	D Ꮋ Unit
Collector to Base Voltage	V_{CBO}	-40	V
Collector to Emitter Voltage	V_{CEO}	-30	V
Emitter to Base Voltage	V_{EBO}	-5	V
Collector Current - DC	I_C	-3	A
Collector Current - Pulse	I_{CP}	-7	A
Collector Power Dissipation	P_C	350	mW
Junction Temperature	T_j	150	ł
Storage Temperature Range	T_{stg}	-55 Ḱ 150	ł

v ˝Ǫ Parameter	ϒ N Symbol	Ⅱ ː ǂ Ţ Test Conditions	ѡ ṇ Ö Min	Ɛ ʒ Ö Typ	ѡ ᶻ Ö Max	D Ꮋ Unit
Collector to Base Breakdown Voltage	V_{CBO}	I_C=-100μA I_E=0	-40			V
Collector to Emitter Breakdown Voltage	V_{CEO}	I_C=-1.0mA I_B=0	-30			V
Emitter to Base Breakdown Voltage	V_{EBO}	I_E=-100μA I_C=0	-5			V

/ Package Dimensions



/ Marking Instructions



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K χ ᵻᵡ ᵌ ᴎ ᒿ

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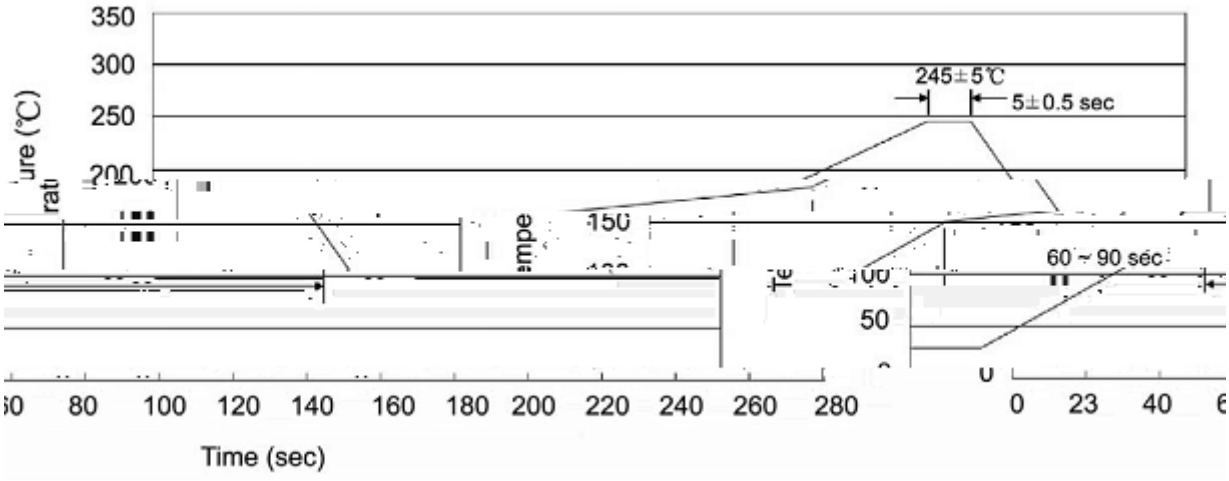
Note:

H: Company Code

72: Product Type Code

Q: h_{FE} Classifications Symbol Code

( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)



ب ˝ χ

1 Ĺ ♬ □ ỷ 25 Ḱ 150 ł ı `H ڑ 60 Ḱ 90sec;

2 Š Ë □ ỷ 245 ° 5 ł ı `H ڑ `Y ﾊ ㎛ 5 ° 0.5sec;

3 ì ˙ ٧ ˛ ↄ ﻩ ỷ ㎛ 2 Ḱ 10 ł /sec.

Note:

1.Preheating:25~150 ł , Time:60~90sec.

2.Peak Temp.:245 ° 5 ł , Duration:5 ° 0.5sec.

3. Cooling Speed: 2~10 ł /sec.

/ Resistance to Soldering Heat Test Conditions

□ ỷ χ 260 ° 5 ł `H ڑ χ 10 ° 1 sec. Temp.:260 ° 5 ł Time:10 ° 1 sec

/ Packaging SPEC.

ↄ ` ٧ Ł / REEL

Package Type	Units					Dimension		(unit mm³)
	Units/Reel /	Reels/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Reel	Inner Box	Outer Box
SOT-23	3,000	10	30,000	6	180,000	7 ρ ×8	180×120×180	390×385×205

/ Notices